

1 Absolute Maximum Ratings

Table 1. Absolute Maximum Rating

Symbol	Parameter	Value	Unit
V_{CES}	Collector-Emitter Voltage ($V_{BE} = 0$)	1500	V
V_{CEO}	Collector-Emitter Voltage ($I_B = 0$)	700	V
I_C	Collector Current	2.5	A
I_{CM}	Collector Peak Current ($t_P < 5\text{ms}$)	4	A
I_B	Base Current	1	A
I_{BM}	Base Peak Current ($t_P < 5\text{ms}$)	2	A
P_{TOT}	Total dissipation at $T_C = 25^\circ\text{C}$	75	W
T_{STG}	Storage Temperature	-65 to 150	$^\circ\text{C}$
T_J	Max. Operating Junction Temperature	150	$^\circ\text{C}$

Table 2. Thermal Data

Symbol	Parameter	Value	Unit
$R_{thJ-case}$	Thermal Resistance Junction-Case Max	1.67	$^\circ\text{C/W}$

2 Electrical Characteristics

Table 3. Electrical Characteristics ($T_{CASE} = 25^{\circ}\text{C}$; unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{CES}	Collector Cut-off Current ($V_{BE} = 0$)	$V_{CE} = 1500\text{V}$ $V_{CE} = 1500\text{V}$ $T_C = 125^{\circ}\text{C}$			0.15 1	mA mA
I_{EBO}	Emitter Cut-off Current ($I_C = 0$)	$V_{EB} = 5\text{V}$			1	mA
$V_{CEO(sus)}$ <i>Note: 1</i>	Collector-Emitter Sustaining Voltage ($I_B = 0$)	$I_C = 10\text{mA}$ $L = 25\text{mH}$	700			V
$V_{CE(sat)}$ <i>Note: 1</i>	Collector-Emitter Saturation Voltage	$I_C = 2\text{A}$ $I_B = 0.9\text{A}$			1	V
$V_{BE(sat)}$ <i>Note: 1</i>	Base-Emitter Saturation Voltage	$I_C = 2\text{A}$ $I_B = 0.9\text{A}$			1.3	V
$I_{s/b}$	Second Breakdown Current	$V_{CE} = 120\text{V}$ $t = 220\mu\text{s}$	2			A
t_s t_f	INDUCTIVE LOAD Storage Time Fall Time	$I_C = 2\text{A}$ $V_{clamp} = 250\text{V}$ $I_{B1} = 0.7\text{A}$ $V_{be(off)} = -5\text{A}$ $R_{bb} = 0$ $L = 200\mu\text{H}$		2 350		μs ns

Note: 1 Pulsed duration = 300 μs , duty cycle $\leq 1.5\%$.

2.1 Typical Characteristics

Figure 1. Safe Operating Area

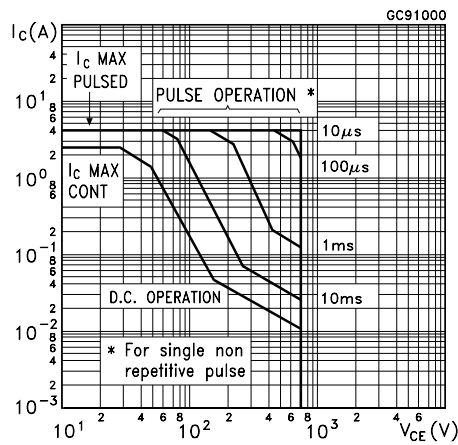


Figure 2. Derating Curve

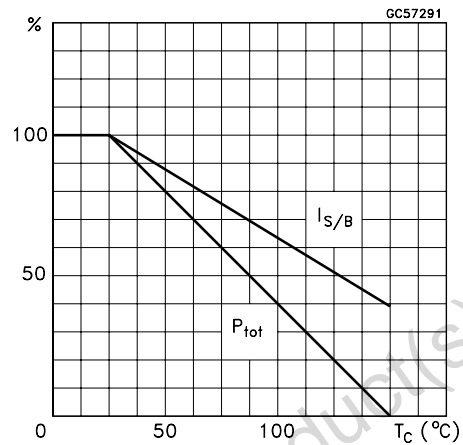


Figure 3. DC Current Gain

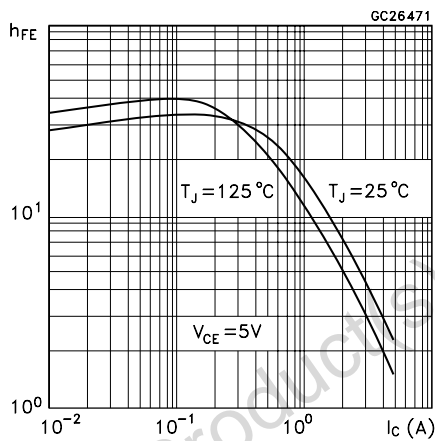


Figure 4. Collector Emitter Saturation Voltage

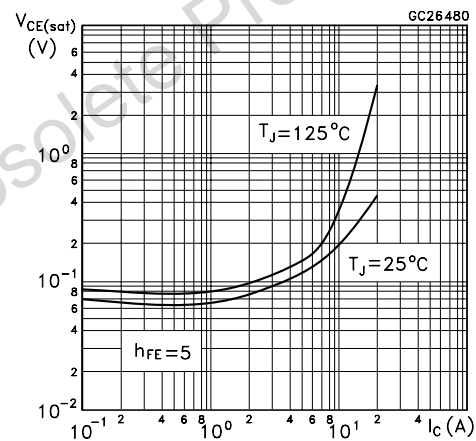


Figure 5. Base Emitter Storage Time

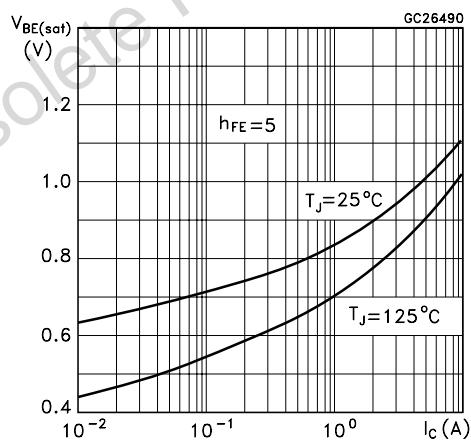


Figure 6. Inductive Fall Time

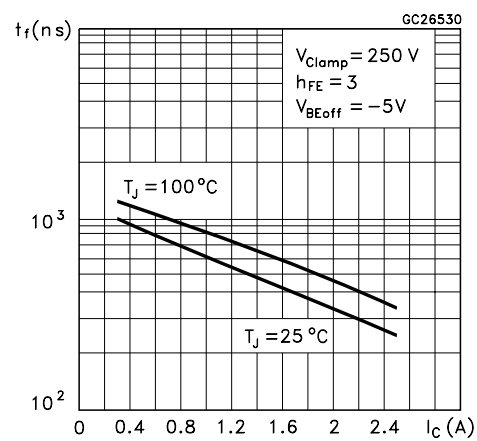


Figure 7. Inductive Storage Time

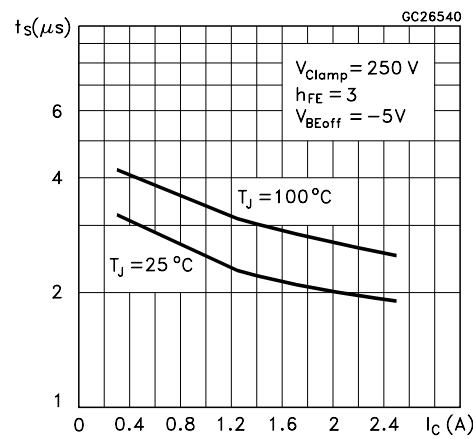
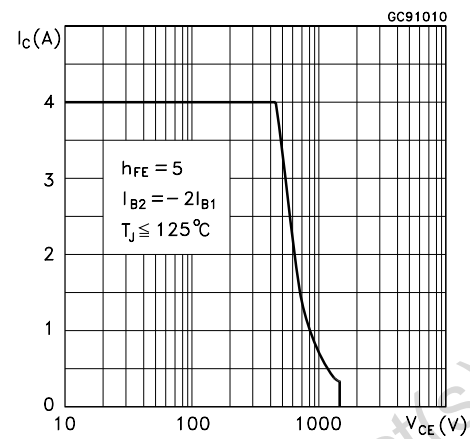
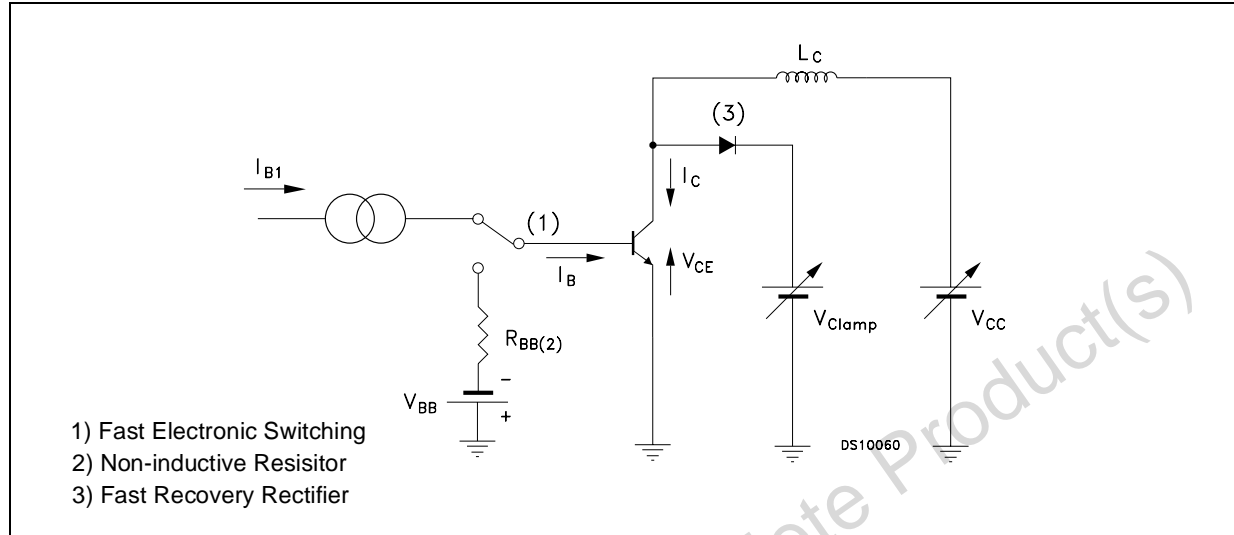


Figure 8. Reverse Biased SOA



3 Test Circuits

Figure 9. Inductive Load Switching Test Circuit

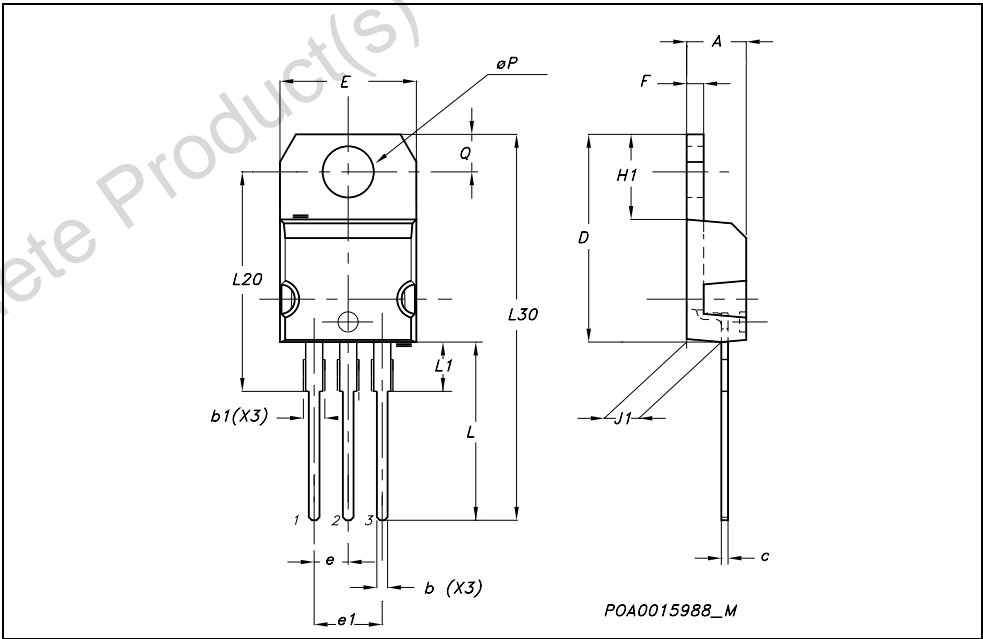


4 Package Mechanical Data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Obsolete Product(s) - Obsolete Product(s)

TO-220 MECHANICAL DATA						
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.15		1.70	0.045		0.066
c	0.49		0.70	0.019		0.027
D	15.25		15.75	0.60		0.620
E	10		10.40	0.393		0.409
e	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.052
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90			1.137	
øP	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116



5 Revision History

Date	Revision	Changes
05-Sep-2001	1	Initial release.
06-Jul-2005	2	Some value change in Table 3 .
25-Jul-2005	3	New Template
19-Aug-2005	4	New ECOPACK® label

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